

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	4703	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering SAME target)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 11:07
S2	1616	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering target)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 11:08
S3	4260	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering WITH target)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 11:08
S4	2288	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering WITH target) AND electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 11:13
S5	117	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering target) AND gate electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 11:14
S6	4569	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering SAME target)	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 11:17
S7	626	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering SAME target) AND gate electrode	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 11:17
S8	115	((Ni OR nickel) SAME (Ta OR tantalum)) AND (sputtering target) AND gate electrode	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 11:18
S9	1	"3763003".prn.	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 12:03
S10	78264	(Ni OR nickel) SAME (Ta OR tantalum)	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 12:58
S11	248	(Ni OR nickel) SAME (Ta OR tantalum) SAME sputtering target	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/10/30 12:59
S12	66	(Ni OR nickel) SAME (Ta OR tantalum) SAME sputtering target	FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/10/30 12:59

S13	5	("5464520" OR "5460793" OR "5618397" OR "6153315" OR "6858116").pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/11/14 14:25
S14	2	("6086725" OR "6190516").pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	ADJ	ON	2007/11/14 15:42
S15	1	US "20060037680" A1	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 15:56
S16	1766	148/675,300,312,426.cds. OR 420/441.cds.	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 16:09
S17	364	S16 AND ((Ni OR nickel) AND (Ta OR tantalum))	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 16:09
S18	318	S16 AND ((Ni OR nickel) SAME (Ta OR tantalum))	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 16:10
S19	37	S16 AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND target	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 16:10
S20	50	S16 AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND (target OR sputter\$4)	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/14 16:17
S21	0	2002/0017458 A1	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 08:32
S22	1	"20020017458" A1	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 08:32
S23	5	("6309593" OR "6352628" OR "5840626" OR "5989988" OR "6485542").pn.	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 08:52
S24	4	"0256035" OR "0069625"	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 09:15
S25	2	"20040256035" OR "20040069625"	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 09:16
S26	2	"20040256035" OR "20040069652"	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 09:17
S27	17328	(Ni OR nickel) AND (tantalum OR Ta)	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/11/15 09:43
S28	7092	sputtering target	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/11/15 09:43
S29	175	S27 AND S28	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/11/15 09:43

S30	301	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputter\$4 AND target	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/11/15 09:44
S31	156	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputtering target	FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/11/15 09:44
S32	1542	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputtering target	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 10:02
S33	116	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputtering target AND gate electrode	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 10:07
S34	116	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputtering target AND gate electrode	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 10:07
S35	17	((Ni OR nickel) SAME (Ta OR tantalum)) AND sputtering target AND gate electrode AND (Ni OR nickel).AB.	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 10:09
S36	27	(Ni OR nickel).AB. AND (Ta OR tantalum) AND sputtering target AND gate electrode	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 10:13
S37	15	("3326782"   "3661564"   "3824161"   "4016054"   "4885134"   "5234512"   "5562783"   "5571308"   "5605582"   "5810983"   "5997807"   "6073830"   "6419806").PN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2007/11/15 11:15
S38	0	("6485542").URPN.	USPAT	ADJ	ON	2007/11/15 11:15
S39	1128	magnetic permeability AND (Ni OR nickel) And (Ta OR tantalum)	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:34
S40	727	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum))	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:34
S41	604	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND heat\$3	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:34
S42	376	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND heat\$3 AND grain	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:35
S43	248	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND heat\$3 AND grain size	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:35

S44	191	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND heat\$3 AND grain size AND ("mu.m" OR micron)	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:36
S45	263	magnetic permeability AND ((Ni OR nickel) SAME (Ta OR tantalum)) AND grain size	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:38
S46	1	"3591362".pn.	US-PGPUB; USPAT	ADJ	ON	2007/11/15 11:54
S47	2	"62040363"	JPO; DERWENT	ADJ	ON	2007/11/15 14:36

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